

# **EZ5053 Solder Stripper**

## DESCRIPTION

EZ5053 is a one part solder and tin stripper, based on nitric acid and ferric nitrate. EZ5053 is an enhanced version of EZ5050 solder stripper, and is specifically designed to strip in small holes. Anti-tarnishing agents and inhibitors have been added to minimize attach on copper and provide a bright finish.

## **Benefits:**

- 1. Long lifetime. Excellent stripping capacity.
- 2. No sludging.
- 3. Leaves a bright copper finish, even when fresh.
- 4. Excellent stability.

# **OPERATING PARAMETERS**

Make-Up	100% EZ5053
Temperature	75-95°F (24-35°C)
Immersion Time	Not applicable
Process	Horizontal Spray
Agitation	Not applicable
Ventilation	Advised
Tanks	Not applicable
Racks and Baskets	Not applicable
Heaters	Teflon coils, Quartz
Filtration	Not necessary
Cooling coils	If temperature exceeds 95°F, Teflon cooling coils are recommended

## PHYSICAL PROPERTIES

Specific gravity	1.17 - 1.20
Appearance	Clear yellow-green liquid
рН	<1

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Odor	Acrid acidic	
Flash Point	>200°F	

#### CONTROL PROCEDURES

EZ5053 solder stripper has been formulated for spray applications. EZ5053 is used at 100% strength and at room temperature. The conveyor speed should be set to achieve a 50-70% breakpoint. The conveyor speed will be high initially due to the high strip rate of fresh EZ5053. The strip speed will slow as the solution is used and it builds up in dissolved metal. For example, the stripping speed starts out at roughly 7-ft/min (for a 4-ft chamber) and slows as the stripper dissolves solder. The stripper can be completely replaced when it slows down to an unacceptable rate. A feed and bleed process can also be set that is based on specific gravity control.

Replenishments should be made to EZ5053 working solution. When the stripping time exceeds four minutes, an addition of fresh EZ5053 should be made. In a spray system, you can maintain a steady state operation by maintaining the specific gravity between 1.26 and 1.28 using a specific gravity control system.

A longer bath life can be achieved by using the concentrated replenisher EZ7001. Make up a new strip solution using EZ5053 and use it until the strip speed is unacceptably slow. Then replenish with EZ7001. It is possible to achieve a specific gravity of 1.38-1.40 when using EZ7001 replenisher.

#### Loading Levels and Solution Replacement

The maximum loading level when using EZ5053 is at a specific gravity of about 1.29 - 1.30 g/mL. At this loading level, the tin content is typically 80 - 90 g/L, and the copper content is typically 5 - 6 g/L. If EZ7001 replenisher is used, then the maximum specific gravity increases to about 1.38 - 1.40 g/mL. At this loading level, the tin content is typically 180 - 200 g/L, and the copper content is typically 10 - 12 g/L.

When any tin / solder strip solution reaches the maximum loading level, some solids will be precipitated out of solution. This usually occurs during cool down periods, like over weekends. Periodic cleaning must be done to remove solids from the strip equipment. The strip solution should be pumped into clean drums, so that it can be reused, when equipment cleaning is complete. We recommend washing out sumps, and cleaning nozzles at least once per month. After the solution is pumped back into the machine, then a breakpoint test should be run, and the conveyor speed set accordingly.

#### **Stripping in Small Holes**

As aspect ratios increase, stripping tin from small holes becomes more challenging. We have found that increasing the temperature of the tin stripper aids in stripping from small holes. We recommend increasing the stripper temperature to 85-90F. Please note that this will increase the activity of the strip chemistry, so the breakpoint should be adjusted accordingly.

#### ANALYSIS

We recommend controlling the EZ5053 bath by specific gravity. If desired, it is possible to analyze the bath through an acid titration, in addition to specific gravity. Analysis procedures are listed below.

## SPECIFIC GRAVITY ANALYSIS

## **Reagents and Equipment needed:**

100 mL volumetric flask



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Analytical balance with a capacity of more than 250 grams, that reads to at least 0.1 grams.

## **Procedure:**

- 1. Tare an empty 100 mL volumetric flask on an analytical balance.
- 2. Mix the EZ5053 solution by running the equipment.
- 3. Take an sample of EZ5053, and cool to room temp.
- 4. Fill the volumetric flask to the mark.
- 5. Weigh the flask and record the mass in grams. (Note: this should be the mass of just the solution)
- 6. Calculation: Specific gravity (g/mL) = (mass in grams) / (100 mL)

Control the specific gravity between 1.26 and 1.28 when using EZ5053 for replenishment. If EZ7001 concentrated replenisher is used, then the specific gravity should be controlled between 1.38 and 1.40. Additions of EZ5053 and/or EZ7001 should be made to reduce the specific gravity into range.

#### ACID TITRATION

#### **Reagents and Equipment needed:**

250 mL Erlenmeyer flask50 mL buret1.0 N NaOH solution1 mL pipetPhenol red indicator solution

## **Titration Procedure:**

- 1. Pipet 2.0 mL of the EZ5053 bath into a 250 mL Erlenmeyer flask and add 50 75 mL of DI water
- 2. Add 2 3 drops of Phenol Red indicator
- 3. Titrate with 1.0N NaOH to the red endpoint
- 4. Calculation: EZ5053 strength (%) = (mLs of 1.0N NaOH used) x 10.4

Maintain the strength of EZ5053 above 75% through additions of EZ5053 or EZ70001 Replenisher.

#### SAFETY AND STORAGE

EZ5053 is a corrosive, acidic solution containing nitric and organic acids. It also contains a strong oxidizer agent. Avoid breathing vapors. Use in a well-ventilated area. When handling concentrate, or working solution, wear protective clothing, gloves and chemical safety goggles. In case of skin contact, remove contaminated clothing and flush affected area with plenty of cold water. In case of eye contact, flush immediately with cold

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water, for at least 15 min, and seek medical attention immediately. Store EZ5053 in its original container. Keep away from direct sunlight and temperature extremes. Protect from freezing.

## WASTE TREATMENT

EZ5053 contains organic and nitric acids. In the process of stripping tin and tin lead from copper clad material, some copper may be removed and dissolved in solution. The spent working solution of EZ5053 may be treated by pH adjusting the solution to a pH above 10 with dilute caustic soda. Allow the precipitate to settle. Filter the solution and make a final pH adjustment of the solution to between 6 and 8 with dilute sulfuric acid before sending the spent solution to chemical treatment sewer for final metal removal. Consult with local officials for further waste disposal regulations.

Please ask a Florida CirTech technical sales rep. for more information regarding waste treatment of this chemistry and our complete line of waste treatment line if additional help or information is desired.

#### MISCELLANEOUS

This product is available in 15-gallon carboys and 55-gallon drums. Consult MSDS sheet for additional information.

